

# Numerical Simulation of Heat Transfer in Microchannel with Twisted Tape Insert

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*Abstract-* A 3D micro channel in transient condition with hydro dynamically fully developed was investigated. The main aim to increase the turbulence of fluid with a helical twisted tape insert and compare with the channel without twisted tape. Since the more the turbulence in fluid more the convective heat transfers. A commercial CFD package is used for investigation. An isothermal wall condition with  $Re$  equal to 100 which is equal to inlet velocity of 0.67m/s is taken as boundary condition. The main aim is to compare the heat transfer rate, axial wall shear stress, skin friction coefficient, Nusselt number, wall fluxes and heat transfer coefficient for the channel with twisted tape with respect to the without twisted tape. It is found that the increase in turbulence occurs in microchannel due to the twisted tape insert. Also it is found that heat transfer characteristics like axial wall shear stress, skin friction coefficient, surface Nusselt number and surface heat transfer coefficient are greater in with twisted tape with respect to without twisted tape. The result revealed that when we use micro channel with twisted tape as compare micro channel with straight tape convective heat transfer increase, convective heat transfer increases because of turbulence in the twisted tape increase. The increased value we can calculate with the help of commercial computational fluid dynamic or commercial CFD. Micro channels are micro in size and have much application in micro electro mechanical system, integrated circuit, biochemical application because it is most suitable method for removing heat flux.

*Keywords:* CFD, Twisted tape, Nusselt number, Reynold number, Micro-channel, Turbulence.

## 1. INTRODUCTION

It is a technique used to increase the thermo hydraulic properties of the heat exchanger devices. It can be classified into three ways i.e.

Active Technique

From manufacturing point of view these techniques are very complex and some external power is needed for desired flow to improve the heat transfer rate. Because of external power needed to manufacture is has very limited application

Different active techniques are as

Mechanical aids: Scrapped heat exchanger and rotating tube heat exchanger are manufactured by mechanical aid techniques. Working principle of these techniques is stirring the fluid by means of rotating the surfaces.

Surface vibration: Mostly it has been used in single phase flow. To obtain a higher convective heat transfer coefficient a frequency of low or high amplitude is applied to the surface.

Fluid vibration: As a replacement for applying vibration at the surface in the fluid pulsation are created. This technique is applied for single phase flow.

Electrostatic fields: This technique is uses electrostatic field from an AC or DC sources to increase the heat

transfer by mixing of fluid. It uses dielectric fluid of heat transfer process.

Injection: By injecting the same fluid or another fluid into the main fluid by the means of a porous interface of the section of the heat transfer area increases the heat transfer rate.

Suction: This technique is appropriate for both single phase flow and two phase flow heat transfer. Removal of vapour by means of porous heated surface in two phase flow and removal of fluid by means of porous heated surface in single phase flow is done by this technique.

Jet impingement: This technique is also appropriate for both single phase flow and two phase flow heat transfer. This method employs the cooling or heating the fluid perpendicularly or obliquely to increase the heat transfer rate at the surface.

Passive technique

These techniques use the power from itself rather than external source which results in increase in pressure drop of fluid. Some modification in geometry or surface cause higher heat transfer rate by disturbing the behavior of fluid.

Different passive techniques are as

Treated surface: This technique includes alteration of the surfaces like pits, cavity or scratches at the heat transfer

area. This method is mainly used in boiling and condensation purposes.

**Rough Surface:** By employing this method a disturbance is created in the region of viscous sub layer. This method is mainly used in single phase turbulent flows.

**Extended surfaces:** The most commonly used extended surfaces are plain fins which is mainly used in heat exchanger. In the present era finned surfaces become very popular due to their ability to interrupt the flow field which in turns the increase the heat transfer rate.

**Displaced enhancement devices:** this method is mainly used in forced convection. They enhance the heat transfer indirectly at the surface of the heat exchanger by shifting the fluid from the surface which is heated or cooled with the bulk fluid.

**Swirl Flow devices:** they create the swirl flow in the axial direction of the channel. The common example of swirl flow devices are helical twisted tape and twisted ducts. it can be used in both type of flow i.e. single phase flow and double phase flow.

**Coiled Tubes:** In single phase flow generation of vortices are caused by curvature of coiled which results in higher heat transfer coefficient. This phenomenon is mainly occurs in regions of boiling.

**Surface tension devices:** This technique enhances the flow of liquid to boiling surface from the condensing surface. Wicked or grooved surface are the best example of this technique.

**Compound Technique**

When two or more techniques used simultaneously to improve the heat transfer rate which is greater than either technique is called compound technique.

## 2. LITERATURE REVIEW

**Khwanhit Wangcharee[2020]** in their paper, have made the Techniques to augment heat transfer. They end up with the detailed analysis of heat transfer applications. This introductory chapter on the augmentation of convective heat transfer provides background for the many applications of this “second generation heat transfer technology” cited throughout this volume. The many available augmentation techniques are described, and some representative performance data and correlations are given for the popular passive techniques.

**A. A. RabienatajDarji[2019]** also have discussed the comparison of wire coil inserts and twisted tape in their work. It was observed and noted that to disturb the central core flow the twisted tapes are the solution but if peripheral annular flow is to be mixed with core flow the wire coil inserts perform better. In context with heat transfer rate they have concluded that twisted tape perform better than the wire coil inserts. In process industries the fluids used have high density because of high viscosity and dirt and thus they need high pumping power. In such cases the pumping power is the important element and is drive to put constraints on selection of passive device. When pumping power is an issue pressure drop adds limitation on type of insert, as twisted tape cause more pressure drop than wire coil inserts.

**C. Thianponget. Al [2018]** works in the condition of force convection by using twisted tape insert of width 16 mm thicknesses 1.2mm, length 0.5m and twist ratio 5.5, 6.5, 8.5 with circular holes of diameter 6mm and conclude that for Re no.range 2000 to 12000, the Nussult number for twisted tape insert with twist ratio 8.5,6.5 and 5.5 was found to be 23.99%, 25.64% and 29.32% respectively also the Friction factor is increased approximately by 0.20%, 0.2673 % and 0.4545 % with twist ratio 8.5, 6.5 and 5.5 respectively.

**A. E. Kabelet. al [2017]** Give a Analysis of Heat Transfer in Pipe with Twisted Tape Inserts to understand the effect of change in pitch of twisted tape on the flow physics, results of Re no.800 and twist ratio 2, 3, 4 and 5 are considered and conclude the variation of twist ratio and Re no.on heat transfer and flow characteristics using twisted tape inserts and also the heat transfer increases with decrease in twist ratio and increase in Reynolds number.

## 3. PROBLEM IDENTIFICATION

From the study of various research papers we have obtained the following problems:

- (1) Geometry was not suitable for higher heat transfer.
- (2) Size and cost of heat transfer equipments was more.
- (3) The main concern for the equipment design is to minimize the flow resistance while enhancing the heat transfer coefficient.
- (4) Performance of heat exchangers can be improved by many augmentation techniques but Increase in pressure drop is always a barrier for heat transfer enhancement

#### 4. RESEARCH OBJECTIVES

The objectives of this work are:

- (1) Enhance the heat transfer with respect to plain tube.
- (2) Reduce the size and cost of heat exchanger.
- (3) The equipment design is to minimize the flow resistance while enhancing the heat transfer coefficient.
- (4) Transfer coefficient.
- (5) Decrease pumping power requirement.

#### 5. METHODOLOGY

The above stated 3D geometry of 2 cases is created by using ANSYS WORKBENCH 15.0. Total number of meshed cell is equal to 160000. The detailed meshed geometry is shown in fig. Apply all the boundary condition and initialize the problem by choosing a suitable solver iterate the problem. The convergence of residual is shown in fig

Case 1

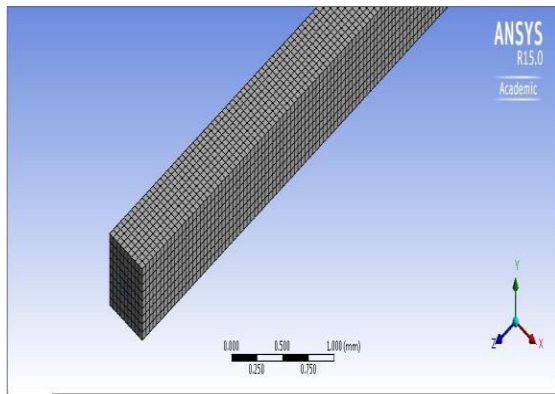


Figure 1: Completed Meshed Geometry of Micro Channel without Twisted Tape

Case 2

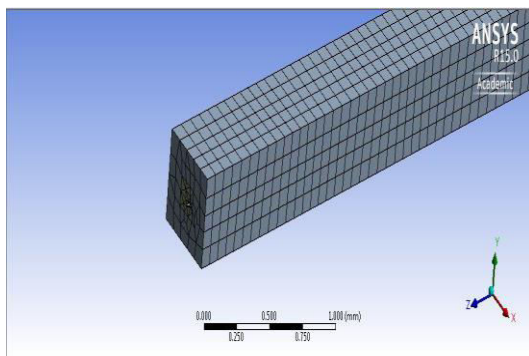


Figure 2: Completed Meshed Geometry of Micro Channel with Twisted Tape

#### Convergence Limit Case 1

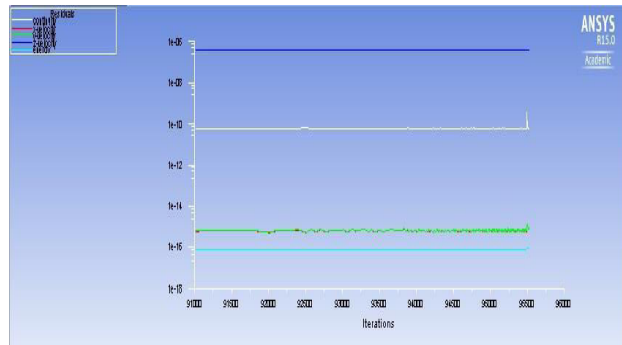


Figure 3: Convergence Residual Of Microchannel without Twisted Tape

Case 2

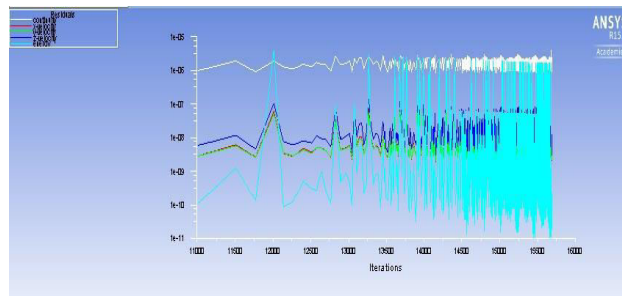


Figure 4: Convergence Residual of Microchannel with Twisted Tape

#### 6. RESULT AND DISCUSSION

##### Axial Wall Shear Stress

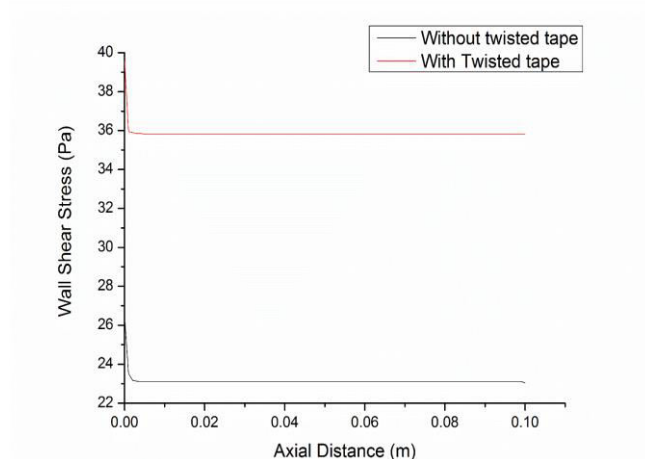


Figure 5: Wall Shear Stress Vs Axial Distance

Table 1: Wall Shear Stress and Axial Distance with Twisted Tape **Surface Nusselt Number**

S.NO.	AXIAL DISTANCE(m)	WALL SHEAR STRESS(Pa)
1	0.00	39
2	0.00125	37
3	0.0025	36
4	0.04	36

Table 2: Wall Shear Stress and Axial Distance without Twisted Tape

S.NO.	AXIAL DISTANCE(m)	WALL SHEAR STRESS(Pa)
1	0.00	25
2	0.00125	24
3	0.0025	23
4	0.04	23

**Skin Friction Coefficient**

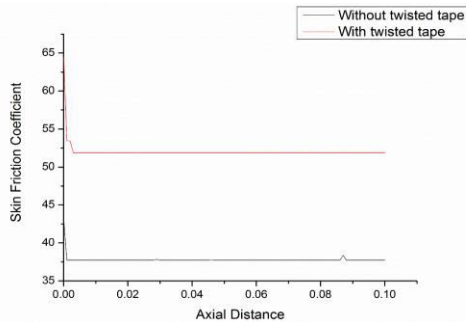


Figure 6: Skin Friction Coefficient Vs Axial Distance

**Surface Heat Transfer Coefficient**

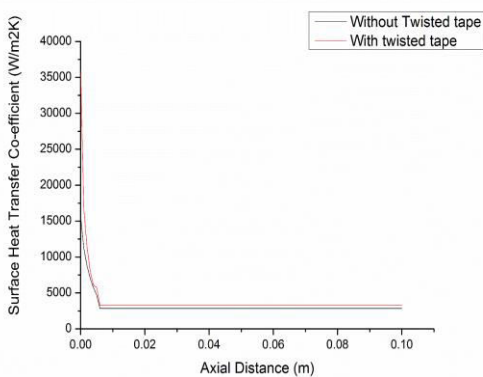


Figure 7: Surface Heat Transfer Coefficient Vs Axial Distance

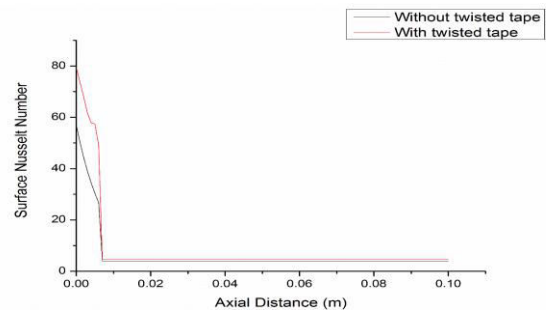


Figure 8: Surface Nusselt Number Vs Axial Distance

Fig 5 shows the trend of axial wall shear stress along the axial length. From the diagram it can be seen that the value of axial wall shear stress is more for twisted tape than the without the twisted tape. This is due to the reason of increase in velocity of at the wall by twisted tape.

Fig 6 shows the trend of skin friction coefficient along the axial length. From the diagram it can be seen that the value of skin friction coefficient is more for twisted tape than without twisted tape. This is due to the reason of increase in wall shear stress at the wall by twisted tape.

Fig. 7 shows the trend of surface heat transfer coefficient along the axial length. From the diagram it can be seen that the value of surface heat transfer coefficient is more for twisted tape than without twisted tape. This is due to the reason that the more convective heat transfer in twisted tape due to turbulence in fluid.

Fig 8 shows the trend of surface nusselt number along the axial distance. From the diagram it can be seen that the value of surface nusselt number is more for twisted tape than without twisted tape. This is due the reason of increase of surface heat transfer coefficient at the wall.

**7. CONCLUSIONS AND FUTURE SCOPE**

1. It is found that the axial wall shear stress increases when the twisted tape insert is employed with the conventional microchannel.
2. It can be concluded that the skin friction coefficient increases when the twisted tape insert is employed with the conventional microchannel.
3. From the above results it is found that surface Nusselt number increases when the twisted tape insert is employed with the conventional microchannel.

4. Also Surface heat transfer coefficient increases when the twisted tape insert is employed with the conventional microchannel.
5. Due to twisted tape insert the increase in turbulence occurs which results in higher convective heat transfer.

It is observed that by inserting the twisted tape in conventional microchannel the parameters like wall shear stress. Skin friction coefficient, surface nusselt number, surface heat transfer coefficient increases along the axial distance. The reason is increase in turbulence by inserting the twisted tape which results in increase in turbulence. Due to this fluid is mixed properly which results more convective heat transfer. Present work is done with the water as working fluid, in which temperature jump and slip velocity does not play an important role. Can change working fluid as air in which temperature jump and slip velocity plays an important role. Change the property like temperature and pressure by implementing the UDF.

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